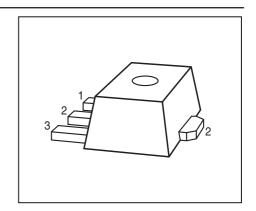


### Low Noise Silicon Bipolar RF Transistor

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 10 mA to 70 mA
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





### **ESD** (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFQ19S	FG	1 = B	2 = C	3 = E	SOT89

**Maximum Ratings** at  $T_A$  = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CEO</sub>	15	V
Collector-emitter voltage	V <sub>CES</sub>	20	
Collector-base voltage	V <sub>CBO</sub>	20	
Emitter-base voltage	$V_{EBO}$	3	
Collector current	I <sub>C</sub>	120	mA
Base current	I <sub>B</sub>	12	
Total power dissipation <sup>1)</sup>	P <sub>tot</sub>	1	W
<i>T</i> <sub>S</sub> ≤ 85°C			
Junction temperature	$T_{J}$	150	°C
Ambient temperature	$T_{A}$	-65 150	
Storage temperature	T <sub>Stg</sub>	-65 150	

#### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	R <sub>thJS</sub>	65	K/W

 $<sup>{}^{1}</sup>T_{\rm S}$  is measured on the collector lead at the soldering point to the pcb

 $<sup>^2</sup>$ For the definition of  $R_{\mathrm{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



# **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	15	-	-	V
$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	, ,				
Collector-emitter cutoff current	I <sub>CES</sub>	-	_	10	μΑ
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	100	μΑ
$V_{\rm EB} = 2 \text{ V}, I_{\rm C} = 0$					
DC current gain	h <sub>FE</sub>	70	100	140	-
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, pulse measured					



**Electrical Characteristics** at  $T_A$  = 25 °C, unless otherwise specified

Parameter  Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)				
Transition frequency	$f_{T}$	4	5.5	-	GHz
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $f$ = 500 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	1.05	1.35	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
emitter grounded					
Collector emitter capacitance	C <sub>ce</sub>	-	0.4	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,					
base grounded					
Emitter-base capacitance	C <sub>eb</sub>	-	3.9	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$ ,					
collector grounded					
Minimum noise figure	NF <sub>min</sub>				dB
$I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 6 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ ,					
f = 900 MHz		_	1.8	-	
f = 1.8 GHz		-	3	-	
Power gain, maximum available <sup>1)</sup>	G <sub>ma</sub>				]
$I_{\rm C}$ = 70 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,					
f = 900 MHz		_	11.5	-	
f = 1.8 GHz		-	7	-	
Transducer gain	$ S_{21e} ^2$				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,					
f = 900 MHz		_	9.5	_	
f = 1.8 GHz		-	4	-	
Third order intercept point at output <sup>2)</sup>	IP <sub>3</sub>	-	32	-	dBm
$V_{CE} = 8 \text{ V}, I_{C} = 70 \text{ mA}, Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt},$					
f = 1.8 GHz					
1dB Compression point	P <sub>-1dB</sub>	-	22	-	1
$V_{CE}$ = 8 V, $I_{C}$ = 70 mA, $Z_{S}$ = $Z_{Sopt}$ , $Z_{L}$ = $Z_{Lopt}$ ,					
f = 1.8 GHz					

 $<sup>{}^{1}</sup>G_{ma} = |S_{21}/S_{12}| (k-(k^{2}-1)^{1/2})$ 

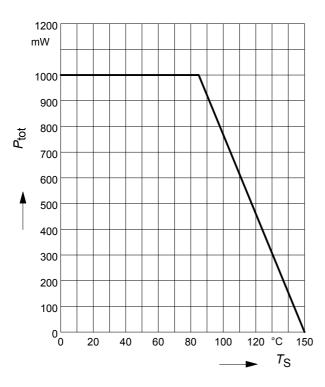
<sup>&</sup>lt;sup>2</sup>IP3 value depends on termination of all intermodulation frequency components.

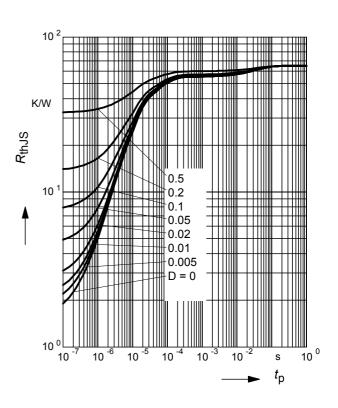
Termination used for this measurement is  $50\Omega$  from 0.2 MHz to 12 GHz



# Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$

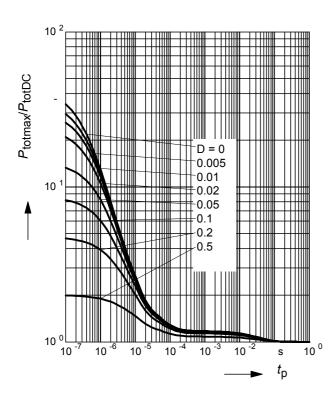
# Permissible Pulse Load $R_{thJS} = f(t_p)$





### **Permissible Pulse Load**

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$$





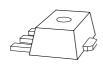
#### **SPICE GP model**

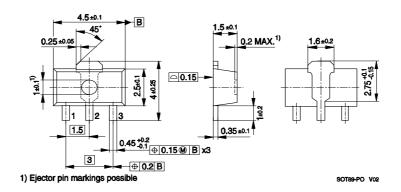
For the SPICE model as well as for S-parameters (including noise parameters) please refer to our internet website <a href="www.infineon.com/rf.models">www.infineon.com/rf.models</a>. Please consult our website and download the latest versions before actually starting your design.

5

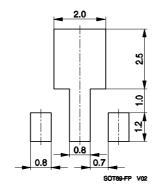


## Package Outline

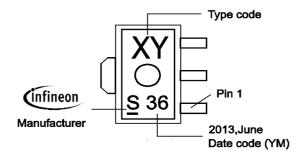




## **Foot Print**

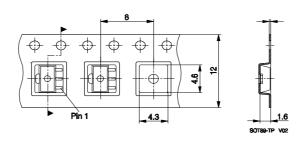


## Marking Layout (Example)



## Standard Packing

Reel Ø 180 mm= 1.000 Pieces/Reel Reel Ø 330 mm= 4.000 Pieces/Reel





Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

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